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# FCP11N60N / FCPF11N60NT N-Channel SupreMOS<sup>®</sup> MOSFET 600 V, 10.8 A, 299 mΩ

## Features

- R<sub>DS(on)</sub> = 255 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 5.4 A
- Ultra Low Gate Charge (Typ. Q<sub>q</sub> = 27.4 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 130 pF)
- 100% Avalanche Tested
- RoHS Compliant

# Application

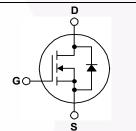
- LCD/LED/PDP TV
- Lighting
- Solar Inverter
- AC-DC Power Supply

GDS

# Description

The SupreMOS<sup>®</sup> MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

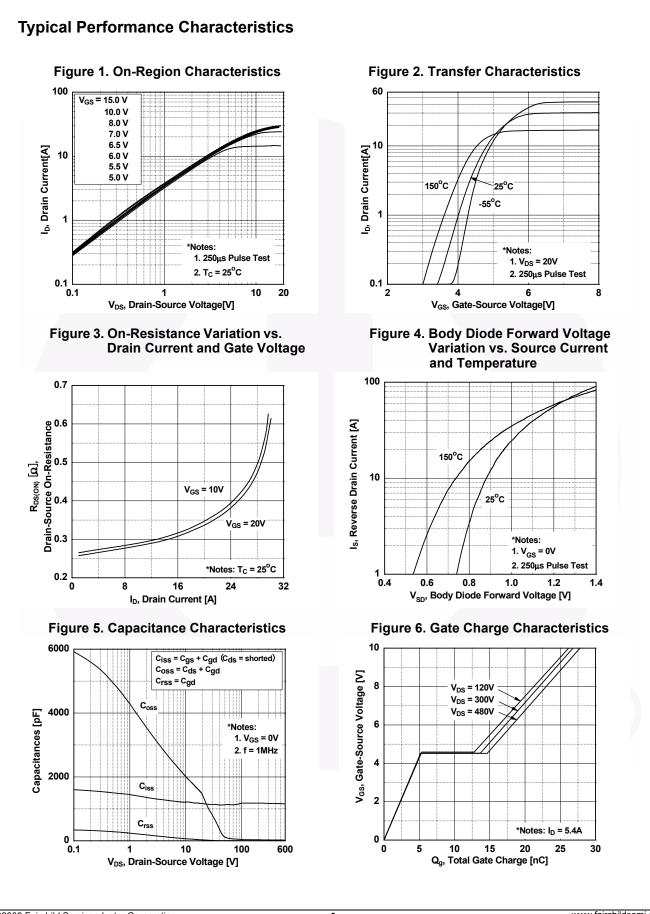
Symbol	Parameter			FCP11N60N	FCPF11N60NT	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			6	V		
V <sub>GSS</sub>	Gate to Source Voltage			±30		V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		10.8	10.8*		
	Drain Current	- Continuous ( $T_C = 100^{\circ}C$ )		6.8	6.8*	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	32.4	32.4*	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	201.7		mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	3.7		А	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	0.94		mJ	
al / alk	MOSFET dv/dt			100		V/ns	
dv/dt	Peak Diode Recovery dv/dt			20		V/ns	
P <sub>D</sub>	Dewer Dissignation	(T <sub>C</sub> = 25°C)		94.0	32.1	W	
	Power Dissipation	- Derate Above 25°C		0.75	0.26	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds300			00	°C		

\*Drain current limited by maximum junction temperature.

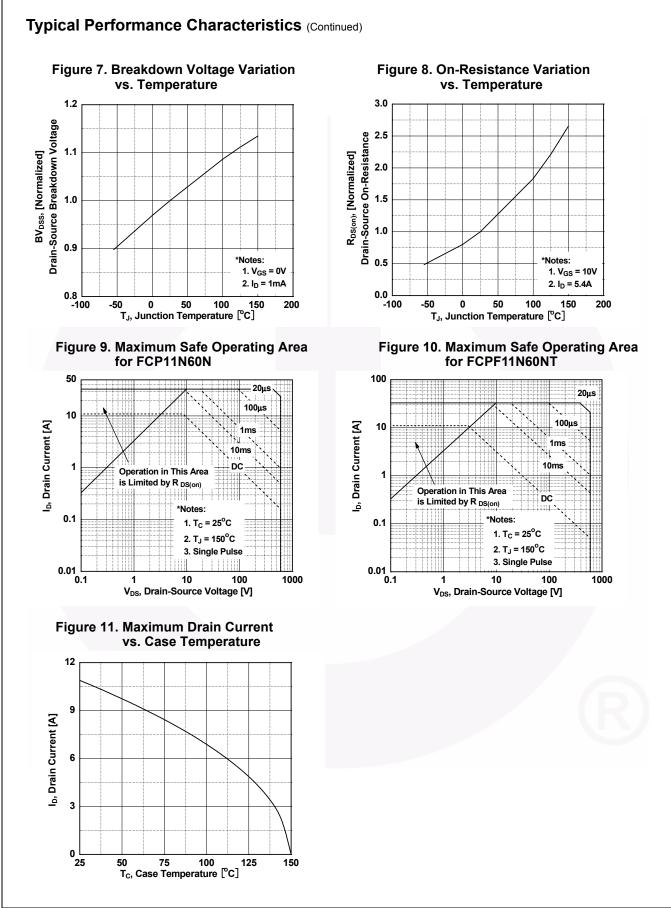
# **Thermal Characteristics**

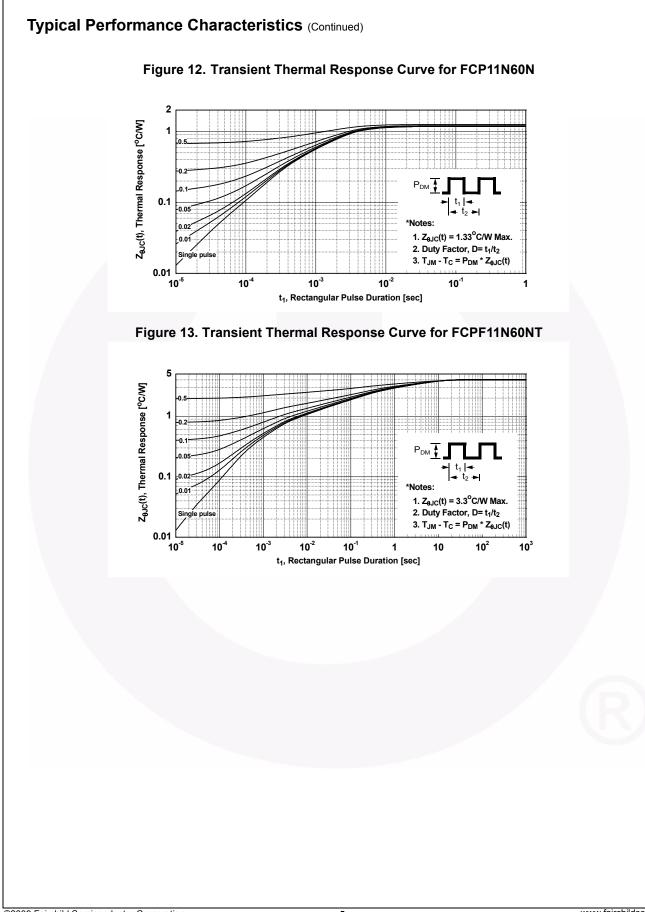
Symbol	Parameter	FCP11N60N	FCPF11N60NT	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.33	3.9	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	0/00

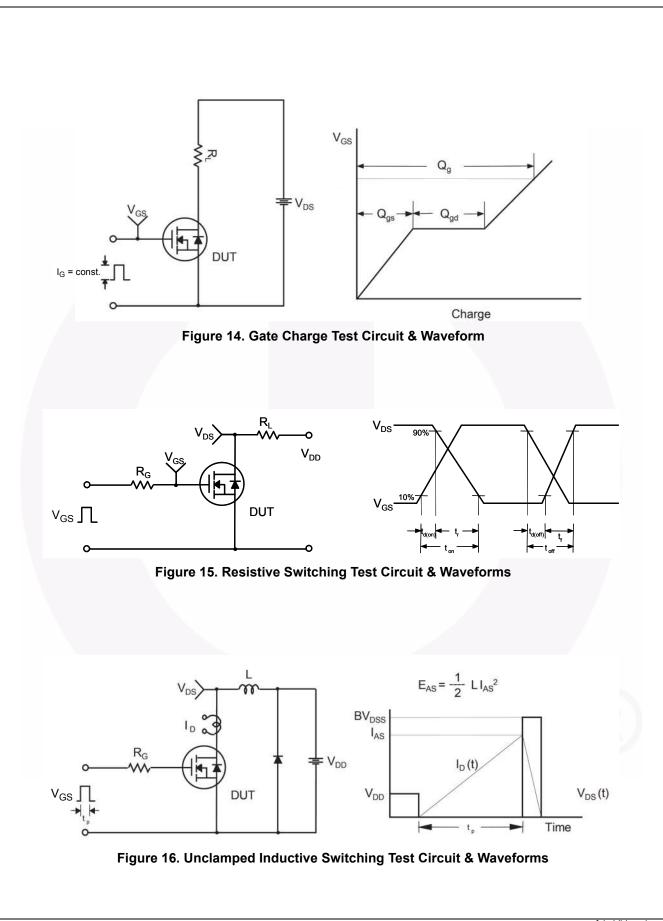
60N 60NT I Chara	FCP11N60N FCPF11N60NT Acteristics T <sub>C</sub> = 25	TO-220 TO-220 °C unless		N/A N/A		N/A N/A		units
			DF Tube	N/A		N/A	E0.	
l Chara	acteristics T <sub>C</sub> = 25	<sup>o</sup> C unless			N/A		50 units	
	Devenueteu				Min	True	Marri	11
	Parameter		Test Condition	IS	Min.	Тур.	Max.	Unit
teristics	5							
Drain to	rain to Source Breakdown Voltage		$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$		600	-	-	V
			$I_D = 1$ mA, Referenced to 25°C		-	0.73	-	V/ºC
Zero Gate Voltage Drain Current					-	-	10	μA
20.0 00			$V_{DS}$ = 480 V, $V_{GS}$ = 0 V, $T_{C}$ = 125°C			-	100	μΛ
Gate to	Body Leakage Current		$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V		-	-	±100	nA
teristics	5							
			$V_{CS} = V_{DS}$ , $I_{D} = 250 \mu$ A			-	4.0	V
	0	ance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.4 \text{ A}$		-	0.255	0.299	Ω
Forward	Transconductance				-	13.5	-	S
haracto	ristics							
-	Input Capacitance Output Capacitance Reverse Transfer Capacitance Output Capacitance		$V_{DS} = 100 V, V_{GS} = 0 V,$ f = 1 MHz $V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz$ $V_{DS} = 0 V to 480 V, V_{GS} = 0 V$		-	1130	1505	pF
								pF
					-		5	pF
					-		-	pF
					-	130	-	pF
			V <sub>DS</sub> = 380 V, I <sub>D</sub> = 5.4 A,		-	27.4	35.6	nC
					-	4.9	-	nC
			03	(Note 4)	-	8.8	-	nC
Equivale	nt Series Resistance (G-				-	2.0	-	Ω
Charact	eristics							
						13.6	37.2	ns
	,	V <sub>DD</sub> = 380 V, I <sub>D</sub> =		5.4 A,				ns
			$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$	-			ns	
			(Note 4)		-	10.0	30.0	ns
1		ource Diod	le Forward Current		_	-	10.8	A
					-	-	32.4	Α
		oltage			-	-	1.2	V
		0			-	268	-	ns
			$dI_{\rm F}/dt = 100  {\rm A}/{\mu s}$		-	3.1	· · ·	μC
	Breakdo Coefficie Zero Ga Gate to I teristics Gate Th Static Dr Forward haracte Input Ca Output C Reverse Output C Effective Total Ga Gate to I Equivale Charact Turn-On Turn-Off Turn-Off Ce Diod Maximun Drain to S Reverse	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Body Leakage Current teristics Gate Threshold Voltage Static Drain to Source On Resista Forward Transconductance haracteristics Input Capacitance Output Capacitance Output Capacitance Effective Output Capacitance Output Capacitance Effective Output Capacitance Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance (G- Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Fall Time <b>ce Diode Characteristics</b> Maximum Continuous Drain to Source	Zero Gate Voltage Drain Current         Gate to Body Leakage Current         teristics         Gate Threshold Voltage         Static Drain to Source On Resistance         Forward Transconductance         haracteristics         Input Capacitance         Output Capacitance         Output Capacitance         Output Capacitance         Output Capacitance         Effective Output Capacitance         Total Gate Charge at 10V         Gate to Drain "Miller" Charge         Equivalent Series Resistance (G-S)         Characteristics         Turn-On Delay Time         Turn-Off Delay Time         Turn-Off Fall Time         ce Diode Characteristics         Maximum Continuous Drain to Source Diode For         Drain to Source Diode Forward Voltage         Reverse Recovery Time	Breakdown Voltage Temperature Coefficient $I_D = 1 \text{ mA}$ , Referenced to $V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$ (Gate to Body Leakage Current $V_{GS} = 430 \text{ V}$ , $V_{DS} = 0 \text{ V}$ deteristicsGate Threshold Voltage $V_{GS} = V_{DS}$ , $I_D = 250 \mu \text{A}$ Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}$ , $I_D = 5.4 \text{ A}$ Forward Transconductance $V_{DS} = 40 \text{ V}$ , $I_D = 5.4 \text{ A}$ Input Capacitance $V_{DS} = 100 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,Gate to Source Capacitance $V_{DS} = 100 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,Effective Output Capacitance $V_{DS} = 380 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,Effective Output Capacitance $V_{DS} = 380 \text{ V}$ , $I_D = 5.4 \text{ A}$ ,Gate to Source Gate Charge $V_{DS} = 380 \text{ V}$ , $I_D = 5.4 \text{ A}$ ,Gate to Drain "Miller" Charge $V_{CS} = 10 \text{ V}$ Equivalent Series Resistance (G-S) $f = 1 \text{ MHz}$ CharacteristicsTurn-On Delay TimeTurn-On Rise Time $V_{CS} = 10 \text{ V}$ , $R_G = 4.7 \Omega$ Turn-Off Fall Time $V_{GS} = 10 \text{ V}$ , $R_G = 4.7 \Omega$ Turn-Off Fall Time $V_{GS} = 0 \text{ V}$ , $I_{SD} = 5.4 \text{ A}$ ,Reverse Recovery Time $V_{GS} = 0 \text{ V}$ , $I_{SD} = 5.4 \text{ A}$ Reverse Recovery Time $V_{GS} = 0 \text{ V}$ , $I_{SD} = 5.4 \text{ A}$		$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	$\begin{array}{ c c c c c c } & I_D = 1 \text{ mA}, \text{Referenced to } 25^{\circ}\text{C} & - & 0.73 \\ \hline & V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V} & - & - \\ \hline & V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^{\circ}\text{C} & - & - \\ \hline & & V_{DS} = 480 \text{ V}, V_{DS} = 0 \text{ V} & - & - & - \\ \hline & & V_{GS} = 430 \text{ V}, V_{DS} = 0 \text{ V} & - & - & - \\ \hline & & & V_{GS} = 130 \text{ V}, V_{DS} = 0 \text{ V} & - & - & - \\ \hline & & & & & V_{GS} = 130 \text{ V}, V_{DS} = 0 \text{ V} & - & - & - \\ \hline & & & & & & & & & & & & & & & & & &$	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$



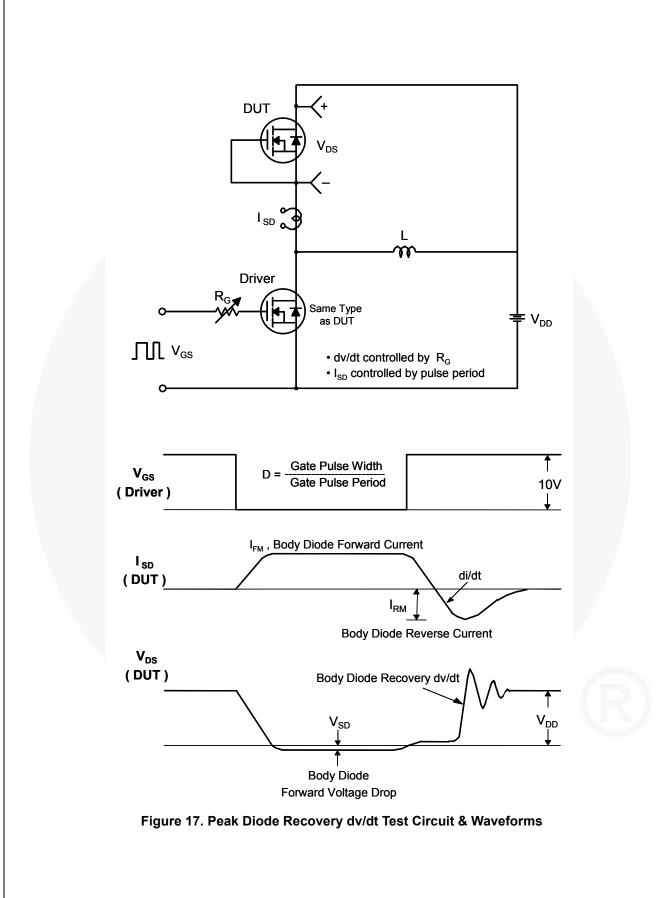
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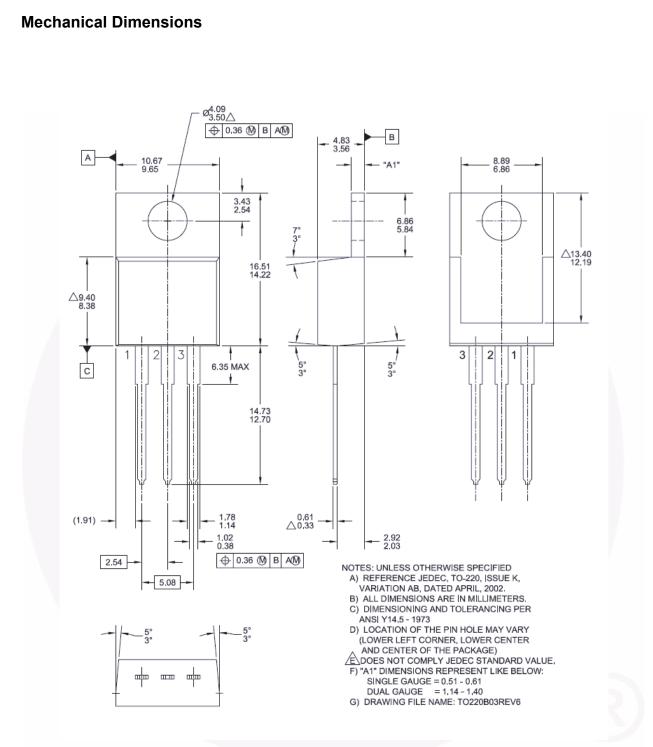






FCP11N60N / FCPF11N60NT — N-Channel SupreMOS<sup>®</sup> MOSFET



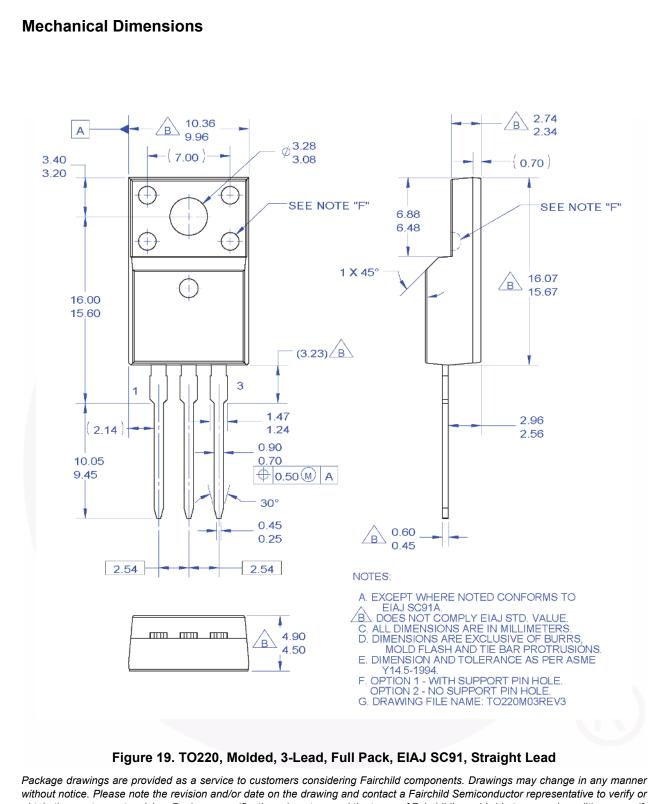


### Figure 18. TO-220, Molded, 3-Lead, Jedec Variation AB

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FCP11N60N / FCPF11N60NT — N-Channel SupreMOS<sup>®</sup> MOSFET



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